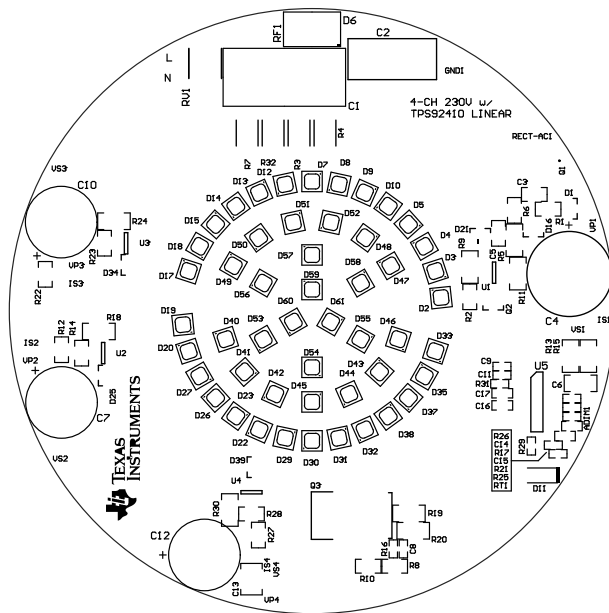
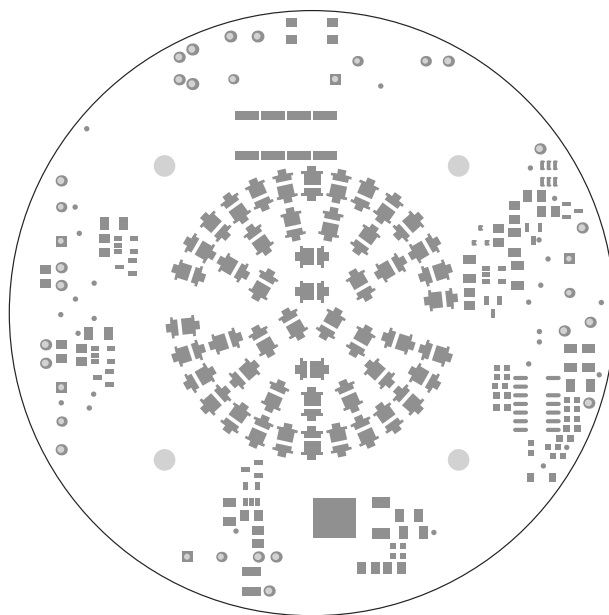
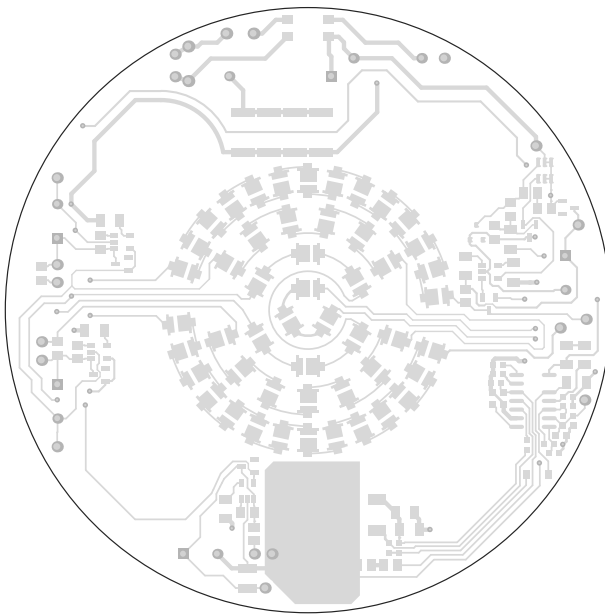




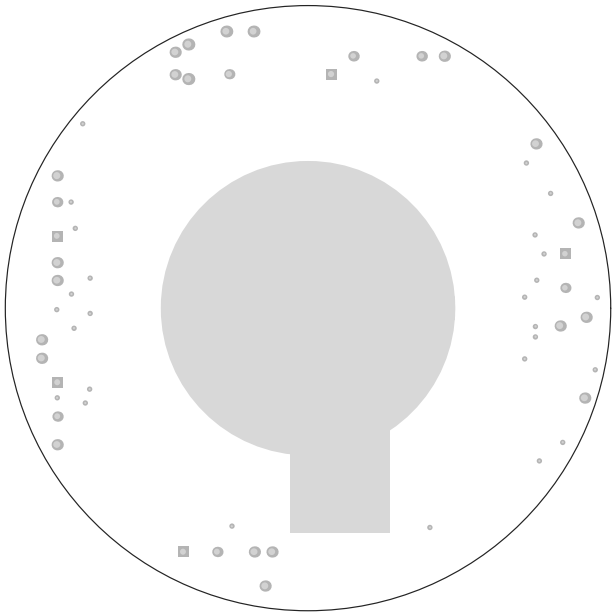
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 12/15/2014 11:08:05 AM	TEXAS INSTRUMENTS	



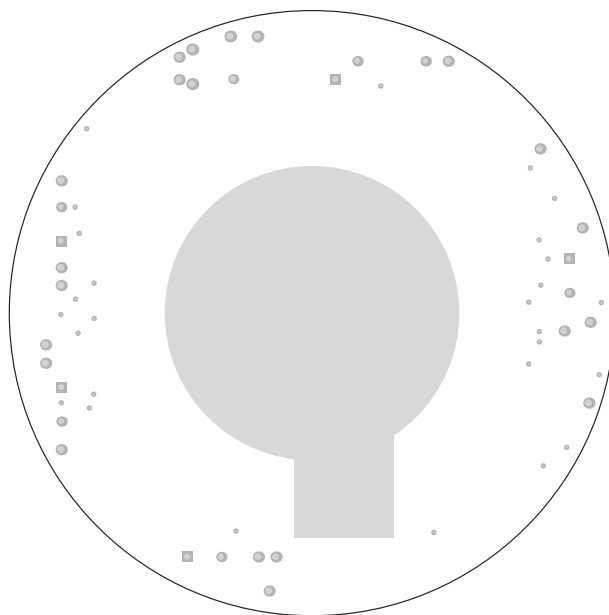
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 12/15/2014 11:08:07 AM	TEXAS INSTRUMENTS	



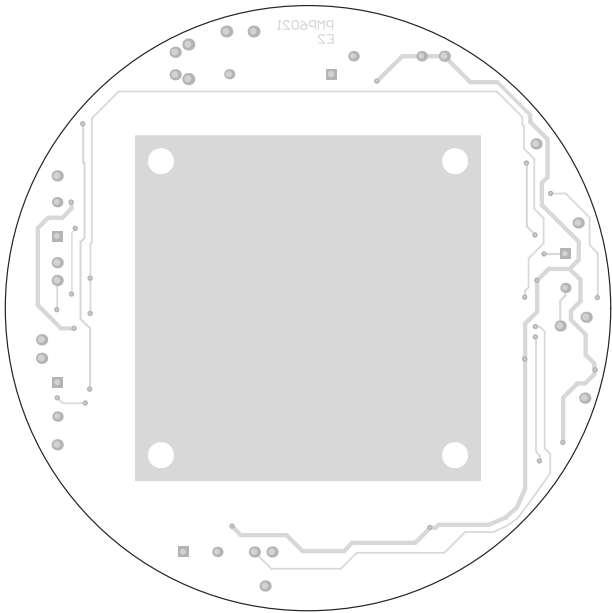
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 12/15/2014 11:08:08 AM	TEXAS INSTRUMENTS	



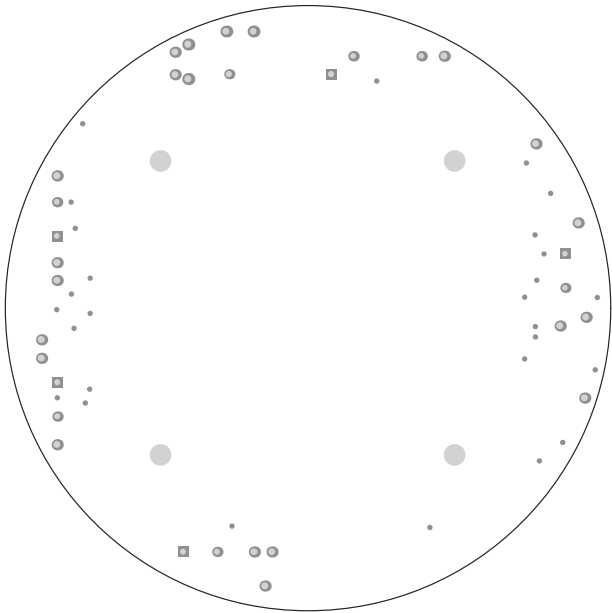
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = MidLayer1			
PLOT NAME = MidLayer1	GENERATED : 12/15/2014 11:08:09 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = MidLayer2			
PLOT NAME = MidLayer2	GENERATED : 12/15/2014 11:08:11 AM	TEXAS INSTRUMENTS	

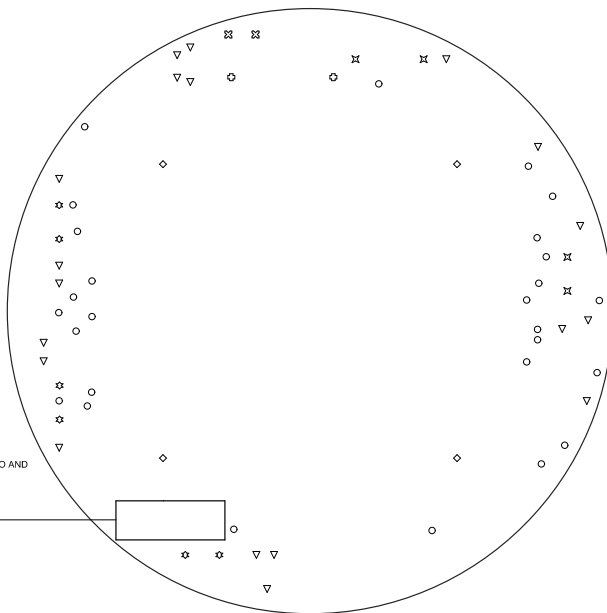


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 12/15/2014 11:08:12 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 12/15/2014 11:08:14 AM	TEXAS INSTRUMENTS	

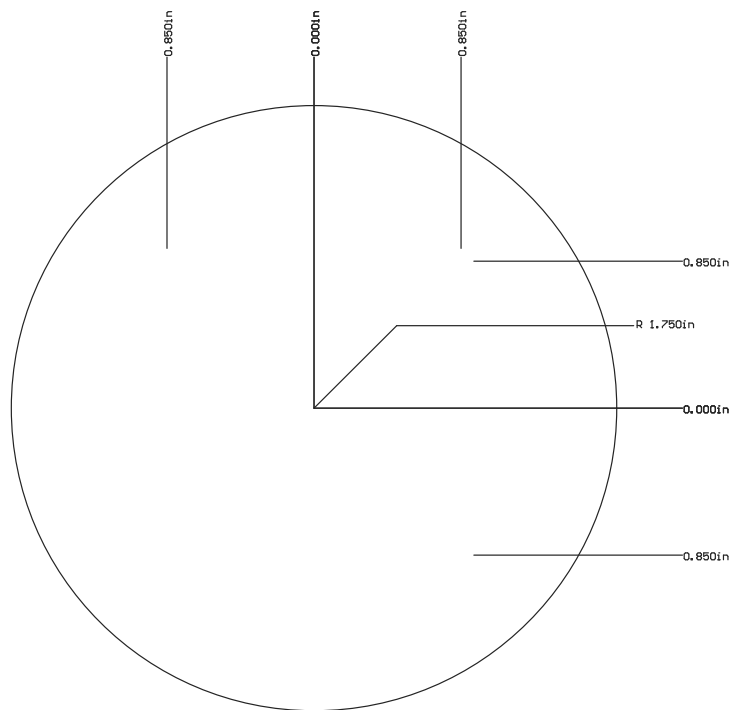
PLACE MFGRS LOGO, UL FLAMMABILITY RATING, Tg TEMP, UL FILE NO AND
DATE CODE HERE ON BOTTOM SIDE



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	27	16mil (0.406mm)	PTH	Round
⊠	4	35.433mil (0.9mm)	PTH	Round
☆	6	37mil (0.94mm)	PTH	Round
⊛	2	39.37mil (1mm)	PTH	Round
⊠	2	42.079mil (1.069mm)	PTH	Round
▽	19	43mil (1.092mm)	PTH	Round
◇	4	128mil (3.251mm)	NPTH	Round
64 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 12/15/2014 11:08:15 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6021	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 12/15/2014 11:08:17 AM		TEXAS INSTRUMENTS

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